Power MOSFETs Silicon N-channel MOS (U-MOSIV)

TPCP8009

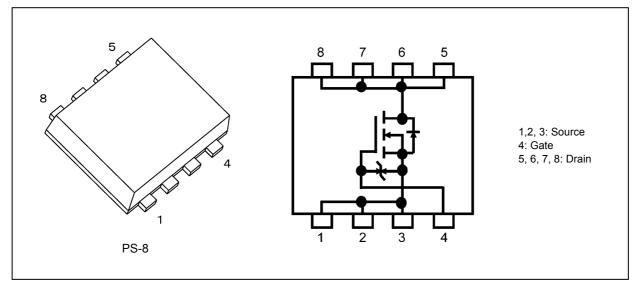
1. Applications

- Motor Drivers
- Mobile Equipment

2. Features

- (1) Small, thin package
- (2) Small gate charge : Q_{SW} = 9.6 nC (typ.)
- (3) Low drain-source on-resistance: $R_{DS(ON)} = 9.5 \text{ m}\Omega \text{ (typ.)} (V_{GS} = 10 \text{ V})$
- (4) Low leakage current: $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 40 \ V)$
- (5) Enhancement mode: V_{th} = 2 to 3 V (V_{DS} = 10 V, I_D = 1 mA)

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics				Rating	Unit
Drain-source voltage			V _{DSS}	40	V
Gate-source voltage			V _{GSS}	±20	
Drain current (DC)		(Note 1)	Ι _D	10	A
Drain current (pulsed)		(Note 1)	I _{DP}	40	
Power dissipation	(t = 5 s)	(Note 2)	PD	2.01	W
Power dissipation	(t = 5 s)	(Note 3)	PD	1.01	W
Single-pulse avalanche energy		(Note 4)	E _{AS}	112	mJ
Avalanche current			I _{AR}	10	A
Channel temperature		(Note 5)	T _{ch}	175	°C
Storage temperature			T _{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

Characteristi	CS		Symbol	Max	Unit
Channel-to-ambient thermal resistance	(t = 5 s)	(Note 2)	R _{th(ch-a)}	74.4	°C/W
Channel-to-ambient thermal resistance	(t = 5 s)	(Note 3)	R _{th(ch-a)}	148.8	°C/W

Note 1: Ensure that the channel temperature does not exceed 175°C.

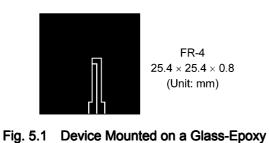
Note 2: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 3: Device mounted on a glass-epoxy board (b), Figure 5.2

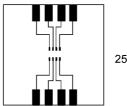
Note 4: V_DD = 24 V, T_ch = 25°C (initial), L = 1.21 mH, R_G = 25 Ω , I_AR = 10 A

Note 5: Merely Channel temperature is guaranteed 175°C.

Storage temperature range is guaranteed as usual (-55 to 150°C).



Board (a)



FR-4 25.4 × 25.4 × 0.8 (Unit: mm)

Fig. 5.2 Device Mounted on a Glass-Epoxy Board (b)

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

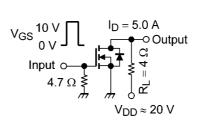
6. Electrical Characteristics

6.1. Static Characteristics (Ta = 25°C unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current	I _{GSS}	V_{GS} = ±16 V, V_{DS} = 0 V	_	_	±10	μA
Drain cut-off current	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V	_	—	10	
Drain-source breakdown voltage	V _{(BR)DSS}	I _D = 10 mA, V _{GS} = 0 V	40	_	_	V
Drain-source breakdown voltage	V _{(BR)DSX}	I _D = 10 mA, V _{GS} = -20 V	20	_	_	
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2	2.5	3	
Drain-source on-resistance	R _{DS(ON)}	V _{GS} = 6 V, I _D = 5 A		12.2	19.5	mΩ
		V _{GS} = 10 V, I _D = 5 A	_	9.5	11.9	

6.2. Dynamic Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		1250	_	pF
Reverse transfer capacitance	C _{rss}		_	165	_	
Output capacitance	C _{oss}		_	265	_	
Switching time (rise time)	tr	See Figure 6.2.1		17	_	ns
Switching time (turn-on time)	t _{on}			30	_	
Switching time (fall time)	t _f]		4.0		
Switching time (turn-off time)	t _{off}			23		



Duty \leq 1%, t_w = 10 μ s

Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

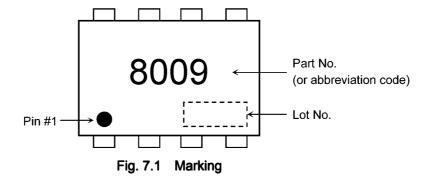
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Qg	$V_{DD}\approx 32 \text{ V}, \text{ V}_{GS} \text{ = } 10 \text{ V}, \text{ I}_{D} \text{ = } 10 \text{ A}$	_	25.1	_	nC
Gate-source charge 1	Q _{gs1}			4.2	_	
Gate switch charge	Q _{SW}		-	9.6	_	
Gate-drain charge	Q _{gd}		_	8.1	_	

6.4. Source-Drain Characteristics ($T_a = 25^{\circ}C$ unless otherwise specified)

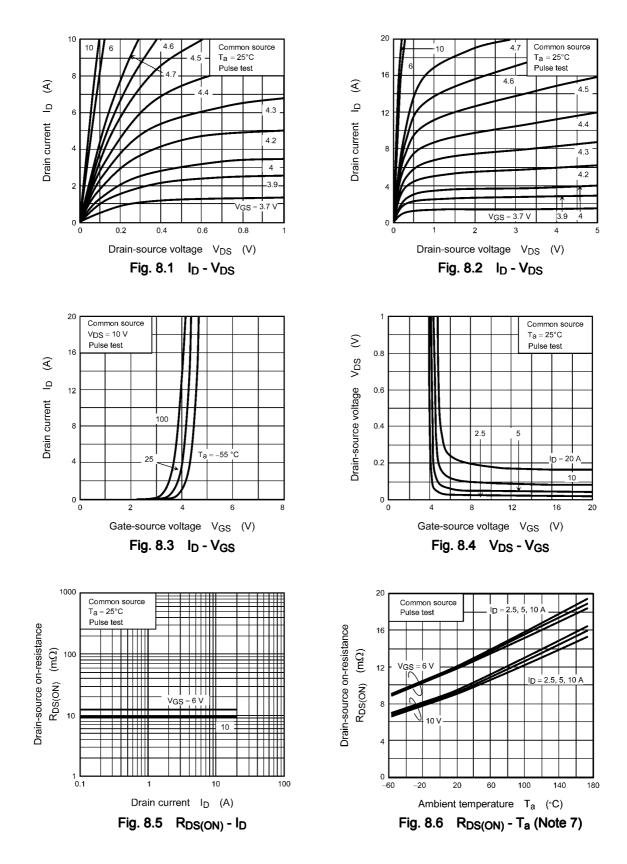
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Reverse drain current (pulsed) (Note 6)	I _{DRP}	—	_	—	40	А
Diode forward voltage	V _{DSF}	I _{DR} = 10 A, V _{GS} = 0 V		_	-1.2	V

Note 6: Ensure that the channel temperature does not exceed 175°C.

7. Marking



8. Characteristics Curves (Note)



1.

0.5

0**L** 0

50

100

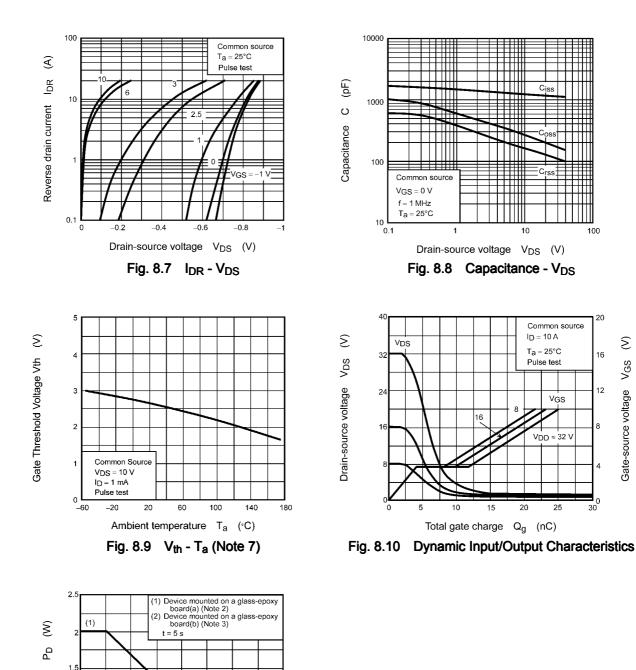
Ambient temperature Ta (°C) Fig. 8.11 P_D - T_a (Note 7) (Guaranteed Maximum)

150

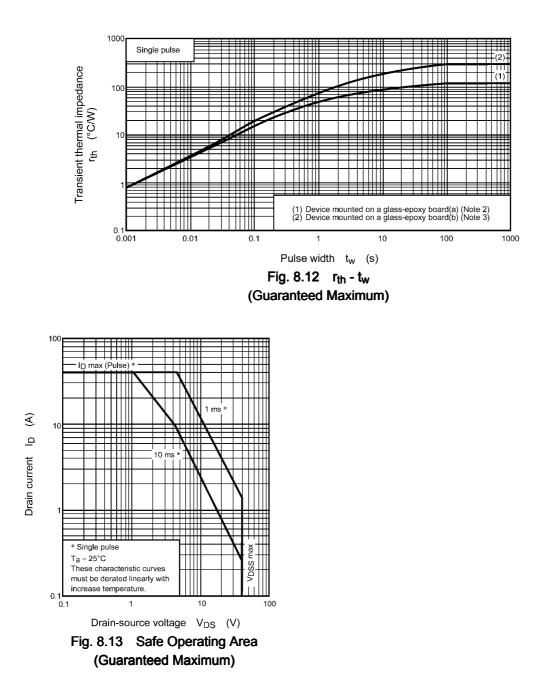
200

(2)

Power dissipation





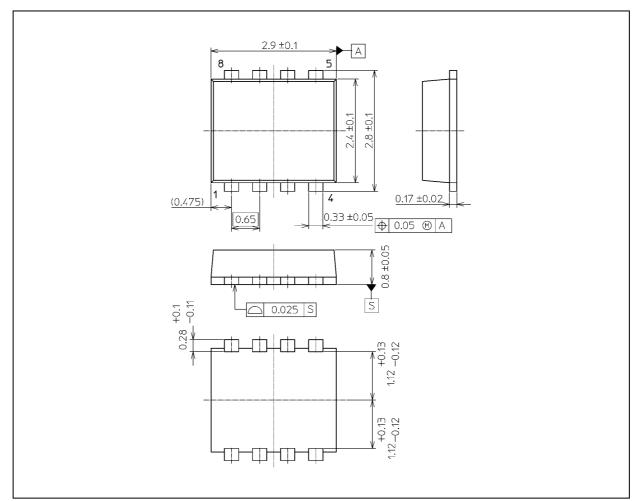


- Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.
- Note 7: Although several performance curves are shown up to a T_a = 175°C, the device is not guaranteed at storage temperatures up to 175°C. The storage temperature (T_{stg}) range is rated at -55°C to 150°C.

TPCP8009

Package Dimensions

Unit: mm



Weight: 0.017 g (typ.)

	Package Name(s)
TOSHIBA: 2-3V1S	
Nickname: PS-8	

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